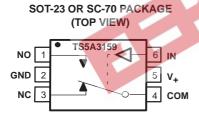


Description

The TS5A3159 is a single-pole double throw (SPDT) analog switch that is designed to operate from 1.65-V to 5.5-V. The device offers a low ON-state resistance and an excellent ON-resistance, matching with the break-before-make feature to prevent signal distortion during the transferring of a signal from one channel to another. The device has an excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

Applications

- Cell Phones
- PDAs
- Portable Instrumentation



FUNCTION TABLE

IN	NC TO COM COM TO NC	NO TO COM COM TO NO
L	ON	OFF
Н	OFF	ON

Features

- Specified Break-Before-Make Switching
- Low ON-State Resistance (1 Ω)
- Control Inputs Are 5-V Tolerant
- Low Charge Injection
- Excellent ON-Resistance Matching
- Low Total Harmonic Distortion
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B) Class II)
 - 1000-V Charged-Device Model (C101)

Summary of Characteristics

 $V_{+} = 5 \text{ V} \text{ and } T_{A} = 25 \text{ }^{\circ}\text{C}$

Configuration	2:1 Multiplexer/ Demultiplexer (1 × SPDT)
Number of channels	1
ON-state resistance (ron)	1.1 Ω
ON-state resistance match (Δr _{on})	0.1 Ω
ON-state resistance flatness (ron(flat))	0.15 Ω
Turn ON/turn OFF time (t _{ON} /t _{OFF})	20 ns/15 ns
Break-before-make time (t _{BBM})	12 ns
Charge injection (QC)	36 pC
Bandwidth (BW)	100 MHz
OFF isolation (O _{ISO})	-65 dB at 1 MHz
Crosstalk (X _{TALK})	-65 dB at 1 MHz
Total harmonic distortion (THD)	0.01%
Leakage current (INO(OFF)/INC(OFF))	±20 nA
Package option	6-pin DBV, DCK, YEP, or YZP



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TS5A3159 1-Ω SPDT ANALOG SWITCH

TEXAS INSTRUMENTS

SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

ORDERING INFORMATION

TA	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING(2)
	NanoStar [™] – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tonocondonal	TS5A3159YEPR	
-40°C to 85°C	NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Tape and reel	TS5A3159YZPR	
	SOT (SOT-23) – DBV	Tape and reel	TS5A3159DBVR	JA8_
	SOT (SC-70) – DCK ⁽²⁾	Tape and reel	TS5A3159DCKR	JA_

⁽¹⁾ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT			
V ₊	Supply voltage range(2)		-0.5	6.5	V			
V _{NO} , V _{COM}	Analog voltage range(2)(3)(4)	3 10						
II/OK	Analog port diode current	V_{NO} , $V_{COM} < 0$ or V_{NO} , $V_{COM} > V_{+}$		±50	mA			
I _{NO} , I _{COM}	ON-state switch current	V_{NO} , $V_{COM} = 0$ to V_{+}		±200	mA			
	ON-state peak switch current(5)	26 73		±400	mA			
VIN	Digital input voltage range(2)(3)	135	-0.5	6.5	V			
lik	Digital input clamp current	V _{IN} < 0		-50	mA			
	Continuous current through V ₊ or GND			±100	mA			
θJA	Package thermal impedance ⁽⁶⁾			165	°C			
T _{stg}	Storage temperature range		-65	150	°C			

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

⁽²⁾ All voltages are with respect to ground unless otherwise specified.

⁽³⁾ The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽⁴⁾ This value is limited to 5.5 V maximum.

⁽⁵⁾ Pulse at 1 ms duration < 10% duty cycle.

⁽⁶⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



Electrical Characteristics for 5-V Supply $V_+ = 4.5 \text{ V}$ to 5.5 V and $T_A = -40 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	NS	TA	٧+	MIN	TYP(1)	MAX	UNIT	
Analog Switch	•									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	٧	
Peak ON resistance	^r peak	$0 \le V_{NO}$ or $V_{NC} \le V_+$, $I_{COM} = -30$ mA,	Switch ON, see Figure 11	25°C Full	4.5 V		1	1.5 1.5	Ω	
ON-state resistance	r _{on}	V_{NO} or $V_{NC} = 2.5 \text{ V}$, $I_{COM} = -30 \text{ mA}$,	Switch ON, see Figure 11	25°C Full	4.5 V		0.75	1.1	Ω	
ON-state resistance match between channels	Δr _{on}	V _{NO} or V _{NC} = 2.5 V, I _{COM} = -30 mA,	Switch ON, see Figure 11	25°C	4.5 V		0.1		Ω	
ON-state resistance		$0 \le V_{NO}$ or $V_{NC} \le V_+$, $I_{COM} = -30$ mA,	Switch ON.	25°C		0.233				
flatness	ron(flat)	V_{NO} or $V_{NC} = 1 \text{ V}$, 1.5 V, 2.5 V, $I_{COM} = -30 \text{ mA}$,	see Figure 11	25°C	4.5 V		0.15		Ω	
NC, NO OFF leakage Current	INC(OFF), INO(OFF)	V_{NC} or $V_{NO} = 0$ to V_+ , $V_{COM} = 0$ to V_+ ,	Switch OFF, see Figure 12	25°C Full	5.5 V	-2 -20	0.2	2 20	nA	
NC, NO ON leakage current	INC(ON), INO(ON)	V _{NC} or V _{NO} = 0 to V ₊ , V _{COM} = Open,	Switch ON, see Figure 13	25°C Full	5.5 V	-4 -40	2.8	4 40	nA	
COM ON leakage current	ICOM(ON)	V _{NC} or V _{NO} = Open, V _{COM} = 0 to V ₊ ,	Switch ON, see Figure 13	25°C Full	5.5 V	-4 -40	0.47	4 40	nA	
Digital Inputs (IN)	•									
Input logic high	VIH			Full		2.4		5.5	V	
Input logic low	VIL			Full		0		0.8	V	
Input leakage current	I _{IH} , I _{IL}	$V_{IN} = 5.5 \text{ V or } 0$		Full	5.5 V	-1		1	μΑ	

⁽¹⁾ $T_A = 25^{\circ}C$

TS5A3159 $1-\Omega$ SPDT ANALOG SWITCH



SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

Electrical Characteristics for 5-V Supply (continued)

 V_{+} = 4.5 V to 5.5 V and T_{A} = -40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	DITIONS	TA	V ₊	MIN	TYP(1)	MAX	UNIT
Dynamic				•					
Turn-on time	ton	$V_{COM} = V_+,$ $R_1 = 50 \Omega,$	C _L = 35 pF, see Figure 15	25°C Full	4.5 V to 5.5 V		20	35 40	ns
		$V_{COM} = V_{+}$	C _I = 35 pF,	25°C	4.5 V to		15	20	
Turn-off time	^t OFF	$R_L = 50 \Omega$	see Figure 15	Full	5.5 V			35	ns
Break-before-make time	[†] BBM	$V_{NC} = V_{NO} = V_{+}/2,$ $R_{L} = 50 \Omega,$	C _L = 35 pF, see Figure 16	25°C Full	4.5 V to 5.5 V	1	12	14.5	ns
Charge injection	QC	C _L = 1 nF, V _{GEN} = 0 V,	see Figure 20	25°C	5 V		36		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	see Figure 14	25°C	5 V		23		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	see Figure 14	25°C	5 V		84		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	see Figure 14	25°C	5 V		84		pF
Digital input capacitance	C _{IN}	$V_{IN} = V_{+}$ or GND,	see Figure 14	25°C	5 V		2.1		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	see Figure 17	25°C	5 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, see Figure 18	25°C	5 V		-65		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, see Figure 19	25°C	5 V		-65		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 600 Hz to 20 kHz, see Figure 21	25°C	5 V		0.01		%
Supply				•					
Positive supply current	I ₊	$V_{ N} = V_{+}$ or GND,	Switch ON or OFF	Full	5.5 V			0.1	μА

⁽¹⁾ $T_A = 25^{\circ}C$



Electrical Characteristics for 3.3-V Supply $V_+=3~V$ to 3.6~V and $T_A=-40^{\circ}C$ to $85^{\circ}C$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ONS	TA	٧+	MIN	TYP(1)	MAX	UNIT
Analog Switch	•				•				
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	V
Peak		$0 \le V_{NO}$ or $V_{NC} \le V_+$,	Switch ON,	25°C	3 V		1.35	2.1	Ω
ON-state resistance	^r peak	$I_{COM} = -24 \text{ mA},$	see Figure 11	Full	3 V			2.1	\$2
ON-state resistance	_	V_{NO} or $V_{NC} = 2 V$,	Switch ON,	25°C	3 V		1.15	1.5	Ω
ON-state resistance	r _{on}	$I_{COM} = -24 \text{ mA},$	see Figure 11	Full	3 V			1.5	52
ON-state resistance match between channels	Δr _{on}	V_{NO} or $V_{NC} = 2 \text{ V}$, 0.8 V, $I_{COM} = -24 \text{ mA}$,	Switch ON, see Figure 11	25°C	3 V		0.11		Ω
ON-state resistance		$0 \le V_{NO} \text{ or } V_{NC} \le V_+,$ $I_{COM} = -24 \text{ mA},$	Switch ON,	25°C	2.1/		0.225		Ω
flatness	ron(flat)	V_{NO} or $V_{NC} = 2 \text{ V}$, 0.8 V, $I_{COM} = -24 \text{ mA}$,	see Figure 11	25°C	3 V		0.25		22
NC, NO	I _{NC(OFF)} ,	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch OFF,	25°C	3.6 V	-2	0.2	2	nA
OFF leakage Current	I _{NO(OFF)}	$V_{COM} = 0$ to V_+ ,	see Figure 12	Full	3.6 V	-20		20	nA
NC, NO	INC(ON),	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch ON,	25°C	3.6 V	-4	2.8	4	nA
ON-leakage Current	INO(ON)	V _{COM} = Open,	see Figure 13	Full	3.6 V	-40		40	IIA
COM	loor worn	V _{NC} or V _{NO} = Open,	Switch ON,	25°C	3.6 V	-4	0.47	4	nA
ON leakage current	ICOM(ON)	$V_{COM} = 0$ to V_+ ,	see Figure 13	Full	3.6 V	-40		40	IIA
Digital Inputs (IN)									
Input logic high	VIH			Full		2		5.5	V
Input logic low	VIL			Full		0	0.6	3	V
Input leakage current	IH, IIL	V _{IN} = 5.5 V or 0		Full	3.6 V	-1		1	μΑ

⁽¹⁾ $T_A = 25^{\circ}C$

TS5A3159 1- Ω SPDT ANALOG SWITCH



SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

Electrical Characteristics for 3.3-V Supply (continued) (V₊ = 3 V to 3.6 V and T_A = -40 °C to 85 °C) (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	DITIONS	TA	٧+	MIN	TYP(1)	MAX	UNIT
Dynamic	•			•					•
Turn-on time	ton	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, see Figure 15	25°C Full	3 V to 3.6 V		30	40 55	ns
Turn-off time	tOFF	$V_{COM} = V_+,$ $R_{I} = 50 \Omega,$	C _L = 35 pF, see Figure 15	25°C Full	3 V to 3.6 V		20	25 40	ns
Break-before-make time	t _{BBM}	$V_{NC} = V_{NO} = V_{+}/2$, $R_{I} = 50 \Omega$,	C _L = 35 pF, see Figure 16	25°C Full	3 V to 3.6 V	1	21	29	ns
Charge injection	QC	C _L = 1 nF, V _{GEN} = 0 V,	see Figure 20	25°C	3.3 V		20		рС
NC, NO OFF capacitance	C _{NC} (OFF), C _{NO} (OFF)	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	see Figure 14	25°C	3.3 V		23		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	see Figure 14	25°C	3.3V		84		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	see Figure 14	25°C	3.3 V		84		pF
Digital input capacitance	C _{IN}	$V_{IN} = V_{+}$ or GND,	see Figure 14	25°C	3.3 V		2.1		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	see Figure 17	25°C	3.3 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, see Figure 18	25°C	3.3 V		-65		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, see Figure 19	25°C	3.3 V		-65		dB
Total harmonic distortion	THD	$R_{L} = 600 \Omega,$ $C_{L} = 50 \text{ pF},$	f = 600 Hz to 20 kHz, see Figure 21	25°C	3.3 V		0.015		%
Supply				•					
Positive supply current	l ₊	$V_{IN} = V_{+}$ or GND,	Switch ON or OFF	Full	3.6 V			0.1	μΑ

 $⁽¹⁾ T_A = 25^{\circ}C$



Electrical Characteristics for 2.5-V Supply $V_+=2.3$ V to 2.7 V and $T_A=-40$ °C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ONS	TA	V ₊	MIN	TYP(1)	MAX	UNIT
Analog Switch				•	•	•			
Analog signal range	VCOM, VNO,VNC					0		٧+	V
Peak		$0 \le V_{NO}$ or $V_{NC} \le V_+$,	Switch ON,	25°C	2.5 V		1.7	2.7	Ω
ON-state resistance	^r peak	$I_{COM} = -8 \text{ mA},$	see Figure 11	Full	2.5 V			2.7	52
ON-state resistance	_	V_{NO} or $V_{NC} = 1.8 V$,	Switch ON,	25°C	2.5 V		1.45	2	Ω
ON-state resistance	ron	$I_{COM} = -8 \text{ mA},$	see Figure 11	Full	2.5 V			2	52
ON-state resistance match between channels	Δr _{on}	V_{NO} or V_{NC} = 0.8 V, 1.8 V, I_{COM} = -8 mA,	Switch ON, see Figure 11	25°C	2.5 V		0.7		Ω
ON-state resistance		$0 \le V_{NO} \text{ or } V_{NC} \le V_+,$ $I_{COM} = -8 \text{ mA},$	Switch ON,	25°C	0.5.1/		0.5		0
flatness	ron(flat)	V_{NO} or $V_{NC} = 0.8 \text{ V}$, 1.8 V, $I_{COM} = -8 \text{ mA}$,	see Figure 11	25°C	2.5 V		0.45		Ω
NC, NO	I _{NC(OFF)} ,	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch OFF,	25°C	2.7 V	-2	0.2	2	nA
Off-Leakage Current	INO(OFF)	$V_{COM} = 0$ to V_+ ,	see Figure 12	Full	2.7 V	-20		20	ΠA
NC, NO	INC(ON),	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch ON,	25°C	2.7 V	-4	2.8	4	nA
On-Leakage Current	INO(ON)	V _{COM} = Open,	see Figure 13	Full	2.7 V	-40		40	nA
COM	loor worn	V _{NC} or V _{NO} = Open,	Switch ON,	25°C	2.7 V	-4	0.47	4	nA
On-Leakage Current	ICOM(ON)	$V_{COM} = 0 \text{ to } V_+,$	see Figure 13	Full	2.7 V	-40		40	IIA
Digital Inputs (IN)									
Input logic high	VIH			Full		1.8		5.5	V
Input logic low	V _{IL}			Full		0	0.6	3	V
Input leakage current	IH, IIL	V _{IN} = 5.5 V or 0		Full	2.7 V	-1		1	μΑ

⁽¹⁾ $T_A = 25^{\circ}C$

TS5A3159 1- Ω SPDT ANALOG SWITCH



SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

Electrical Characteristics for 2.5-V Supply (continued) $V_+ = 2.3 \text{ V}$ to 2.7 V and $T_A = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	DITIONS	TA	٧+	MIN	TYP(1)	MAX	UNIT
Dynamic	•								
Turn-on time	tON	$V_{COM} = V_+,$ $R_L = 50 \Omega,$	C _L = 35 pF, see Figure 15	25°C Full	2.3 V to 2.7 V		40	55 70	ns
Turn-off time	tOFF	V _{COM} = V ₊ , R _L = 50 Ω,	C _L = 35 pF, see Figure 15	25°C Full	2.3 V to 2.7 V		30	40 55	ns
Break-before-make time	tBBM	$V_{NC} = V_{NO} = V_{+}/2,$ $R_{L} = 50 \Omega,$	C _L = 35 pF, see Figure 16	25°C Full	2.3 V to 2.7 V	1	33	39	ns
Charge injection	QC	C _L = 1 nF, V _{GEN} = 0 V,	see Figure 20	25°C	2.5 V		13		рC
NC, NO OFF capacitance	C _{NC} (OFF), C _{NO} (OFF)	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	see Figure 14	25°C	2.5 V		23		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	see Figure 14	25°C	2.5V		84		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	see Figure 14	25°C	2.5 V		84		pF
Digital input capacitance	C _{IN}	$V_{IN} = V_{+}$ or GND,	see Figure 14	25°C	2.5 V		2.1		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	see Figure 17	25°C	2.5 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, see Figure 18	25°C	2.5 V		-64		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, see Figure 19	25°C	2.5 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega$, $C_L = 50 pF$,	f = 600 Hz to 20 kHz, see Figure 21	25°C	2.5 V		0.025		%
Supply				•					
Positive supply current	I ₊	$V_{IN} = V_{+}$ or GND,	Switch ON or OFF	Full	2.7 V			0.1	μΑ

⁽¹⁾ $T_A = 25^{\circ}C$



Electrical Characteristics for 1.8-V Supply $V_+=1.65~V$ to 1.95 V and $T_A=-40^{\circ}C$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	ons	TA	٧+	MIN	TYP(1)	MAX	UNIT	
Analog Switch					•					
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		٧+	V	
Peak		$0 \le V_{NO}$ or $V_{NC} \le V_+$,	Switch ON,	25°C	1.8 V		4	4.9	Ω	
ON-state resistance	^r peak	$I_{COM} = -2 \text{ mA},$	see Figure 11	Full	1.0 V			4.9	52	
ON-state resistance	r	V_{NO} or $V_{NC} = 1.5 V$,	Switch ON,	25°C	1.8 V		1.7	3.2	Ω	
OIV-State resistance	r _{on}	$I_{COM} = -2 \text{ mA},$	see Figure 11	Full	1.0 V			3.2	52	
ON-state resistance	4	V_{NO} or $V_{NC} = 0.6 \text{ V}$, 1.5 V,	Switch ON,	25°C	401/		0.7			
match between channels	∆r _{on}	$I_{COM} = -2 \text{ mA},$	see Figure 11	Full	1.8 V		0.7		Ω	
		$0 \le V_{NO}$ or $V_{NC} \le V_+$,		25°C			1.85			
ON-state resistance	F (5)	ron(flot)	$I_{COM} = -2 \text{ mA},$	Switch ON,	Full	4.0.1/		1.85		
flatness	ron(flat)	V_{NO} or $V_{NC} = 0.6 \text{ V}, 1.5 \text{ V},$	see Figure 11	25°C	1.8 V		0.9		Ω	
		$I_{COM} = -2 \text{ mA},$		Full			0.9			
NC, NO	INC(OFF),	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch OFF,	25°C	1.95 V	-2	0.2	2	nA	
Off-Leakage Current	INO(OFF)	$V_{COM} = 0 \text{ to } V_+,$	see Figure 12	Full	1.93 V	-20		20	IIA	
NC, NO	INC(ON),	V_{NC} or $V_{NO} = 0$ to V_+ ,	Switch ON,	25° C	1.95 V	-4	2.8	4	nA	
On-Leakage Current	INO(ON)	V _{COM} = Open,	see Figure 13	Fuli	1.95 V	-40		40	IIA	
COM		V _{NC} or V _{NO} = Open,	Switch ON,	25°C	4.05.\/	-4	0.47	4	^	
On-Leakage Current	ICOM(ON)	$V_{COM} = 0$ to V_+ ,	see Figure 13	Full	1.95 V	-40		40	nA	
Digital Inputs (IN)										
Input logic high	VIH			Full		1.5		5.5	V	
Input logic low	VIL			Full		0	0.0	3	V	
Input leakage current	I _{IH} , I _{IL}	V _{IN} = 5.5 ∨ or 0		Full	1.95 V	-1		1	μА	

 $⁽¹⁾ T_A = 25^{\circ}C$

1- Ω SPDT ANALOG SWITCH



SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

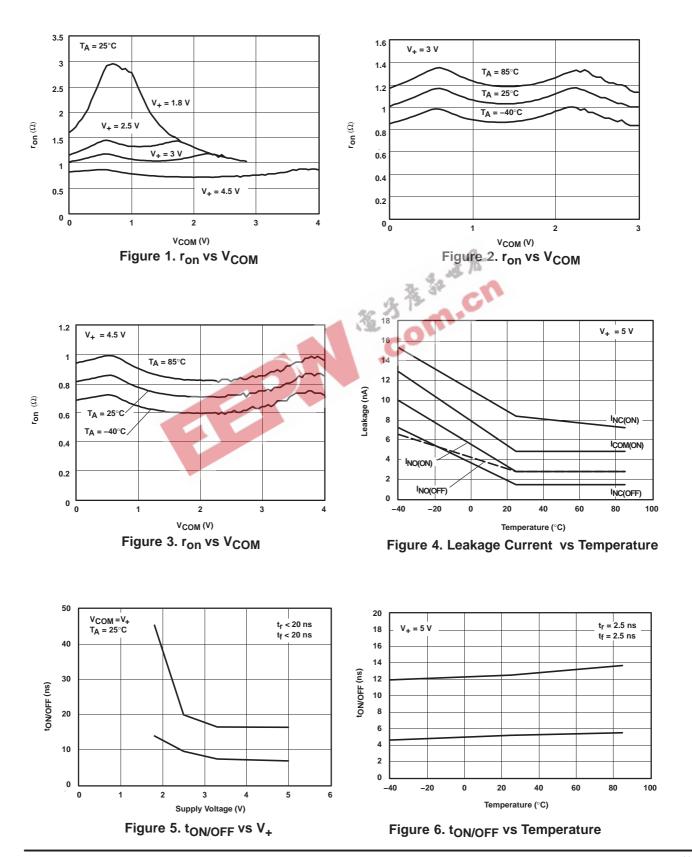
Electrical Characteristics for 1.8-V Supply (continued) $V_+ = 1.65 \text{ V}$ to 1.95 V and $T_A = -40 ^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITI	ONS	TA	٧+	MIN	TYP(1)	MAX	UNIT
Dynamic									
Turn-on time	tON	V _{COM} = V ₊ ,	C _L = 35 pF,	25°C	1.65 V to		65	70	ns
	OIV	$R_L = 50 \Omega$	see Figure 15	Full	1.95 V			95	
Turn-off time	tOFF	$V_{COM} = V_{+}$	$C_L = 35 pF$,	25°C	1.65 V to		40	55	ns
	OFF	$R_L = 50 \Omega$,	see Figure 15	Full	1.95 V			70	113
Break-before-make	4	$V_{NC} = V_{NO} = V_{+}/2,$	$C_L = 35 pF$,	25°C	1.65 V to	1	60	72	
time	^t BBM	$R_L = 50 \Omega$,	see Figure 16	Full	1.95 V	0.5			ns
Charge injection	QC	C _L = 1 nF, V _{GEN} = 0 V,	see Figure 20	25°C	1.8 V		13		рС
NC, NO OFF capacitance	C _{NC(OFF)} , C _{NO(OFF)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF,	see Figure 14	25°C	1.8 V		23		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON,	see Figure 14	25°C	1.8V		84		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	see Figure 14	25°C	1.8 V		84		pF
Digital input capacitance	C _{IN}	$V_{IN} = V_{+}$ or GND,	see Figure 14	25°C	1.8 V		2.1		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON,	see Figure 17	25°C	1.8 V		100		MHz
OFF isolation	O _{ISO}	$R_L = 50 \Omega$, f = 1 MHz,	Switch OFF, see Figure 18	25°C	1.8 V		-63		dB
Crosstalk	XTALK	$R_L = 50 \Omega$, $f = 1 MHz$,	Switch ON, see Figure 19	25°C	1.8 V		-63		dB
Supply									
Positive supply current	l ₊	$V_{IN} = V_{+}$ or GND,	Switch ON or OFF	Full	1.95 V			0.1	μΑ

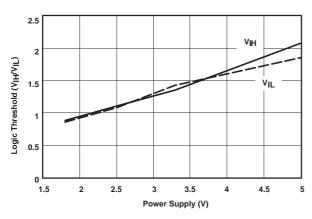
 $⁽¹⁾ T_A = 25^{\circ}C$



TYPICAL PERFORMANCE







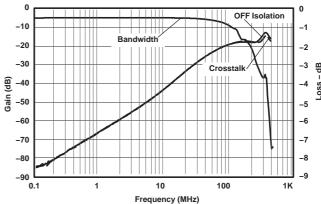
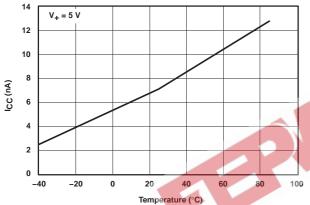


Figure 7. Logic Threshold vs Power Supply

Figure 8. Frequency Response



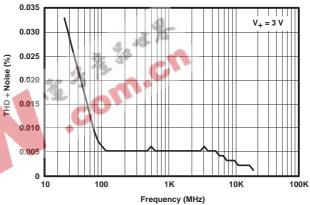


Figure 9. Power-Supply Current vs Temperature

Figure 10. Total Harmonic Distortion (THD) vs Frequency



PIN DESCRIPTION

PIN NUMBER	NAME	DESCRIPTION	
1	NO	Normally-open terminal	
2	GND	Digital ground	
3	NC	Normally-closed terminal	
4	COM	Common terminal	
5	V ₊	Power supply	
6	IN	Digital control pin to connect the COM terminal to the NO or NC terminals	

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION				
VCOM	Voltage at COM				
V _{NC}	Voltage at NC				
VNO	Voltage at NO				
r _{on}	Resistance between COM and NC or COM and NO ports when the channel is ON				
^r peak	Peak ON-state resistance over a specified voltage range				
$\Delta r_{\sf on}$	Difference of ron between channels				
ron(flat)	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions				
INC(OFF)	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worst-case input and output conditions				
I _{NO(OFF)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worst-case input and output conditions				
INC(ON)	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) being open				
I _{NO(ON)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) being open				
I _{COM(ON)}	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) being open				
VIH	Minimum input voltage for logic high for the control input (IN)				
V _{IL}	Minimum input voltage for logic low for the control input (IN)				
VIN	Voltage at IN				
I _{IH} , I _{IL}	Leakage current measured at IN				
tON	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog outputs (COM, NC, or NO) signal when the switch is turning ON.				
tOFF	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog outputs (COM, NC, or NO) signal when the switch is turning OFF.				
^t BBM	Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state.				
QC	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_O$, C_L is the load capacitance and ΔV_O is the change in analog output voltage.				

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SCDS174A - AUGUST 2004 - REVISED SEPTEMBER 2004

PARAMETER DESCRIPTION (continued)

SYMBOL	DESCRIPTION	
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF	
C _{NO(OFF)}	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF	
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON	
C _{NO(ON)}	Capacitance at the NO port when the corresponding channel (NO to COM) is ON	
C _{COM(ON)}	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON	
C _{IN}	Capacitance of IN	
O _{ISO}	OFF isolation of the switch is a measurement OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state.	
X _{TALK}	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NO This is measured in a specific frequency and in dB.	
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.	
I ₊	Static power supply current with the control (IN) pin at V ₊ or GND	
ΔΙ+	This is the increase in I ₊ for each control (IN) input that is at the specified voltage, rather than at V ₊ or GND.	





PARAMETER MEASUREMENT INFORMATION

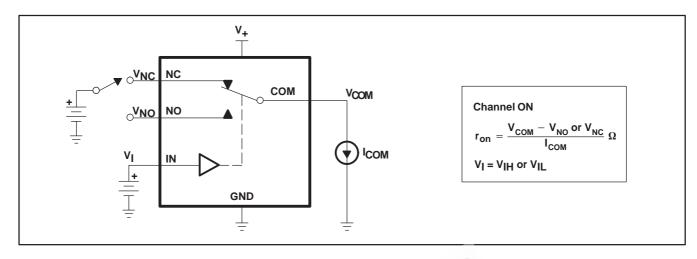


Figure 11. ON-State Resistance (ron)

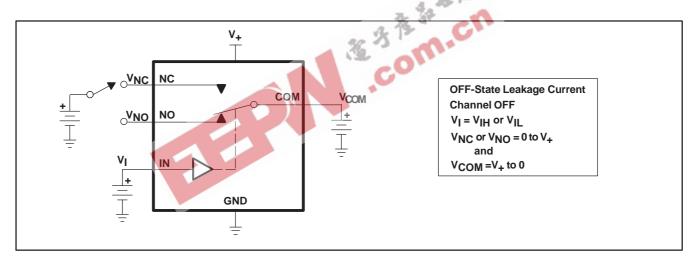


Figure 12. OFF-State Leakage Current ($I_{NC(OFF)}$, $I_{NO(OFF)}$)

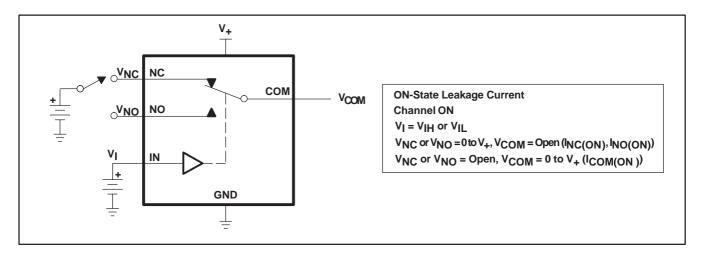


Figure 13. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NC(ON)}$, $I_{NO(ON)}$)



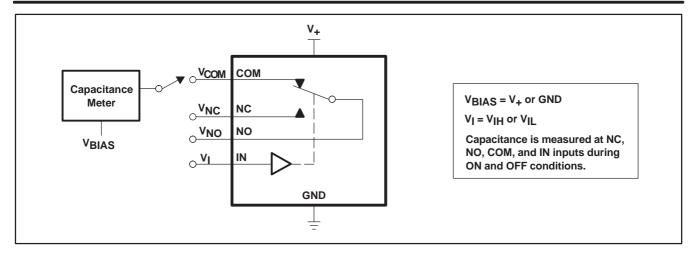
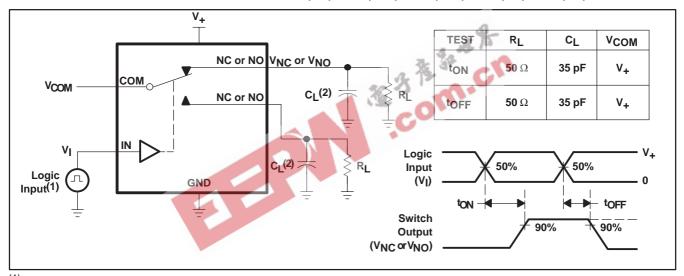


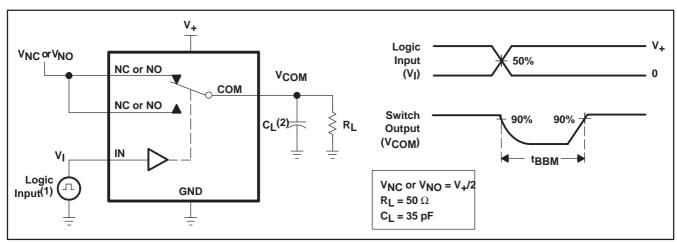
Figure 14. Capacitance (C_I , $C_{COM(ON)}$, $C_{NC(OFF)}$, $C_{NO(OFF)}$, $C_{NC(ON)}$, $C_{NO(ON)}$)



(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f < 5$ ns.

(2) C_L includes probe and jig capacitance.

Figure 15. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})



(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_\Gamma < 5$ ns. $t_f < 5$ ns.

(2) C_I includes probe and jig capacitance.

Figure 16. Break-Before-Make Time (t_{BBM})



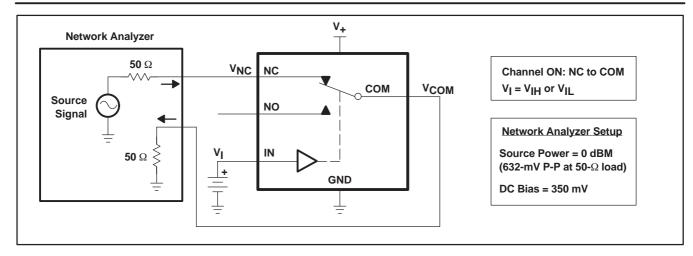


Figure 17. Bandwidth (BW)

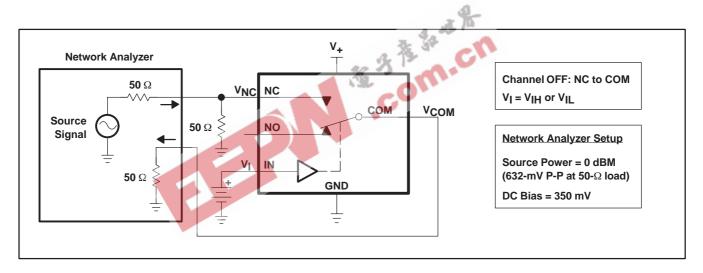


Figure 18. OFF Isolation (OISO)

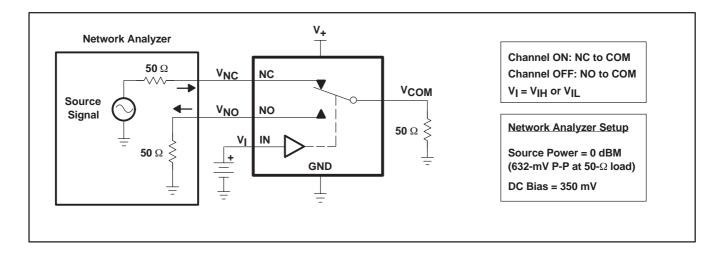
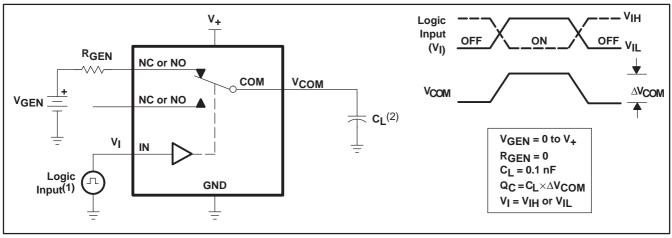


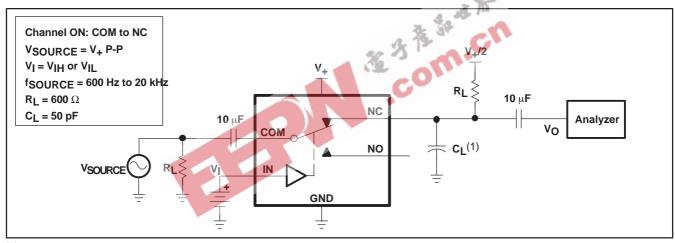
Figure 19. Crosstalk (X_{TALK})





- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f < 5 ns.
- (2) C_L includes probe and jig capacitance.

Figure 20. Charge Injection (Q_C)

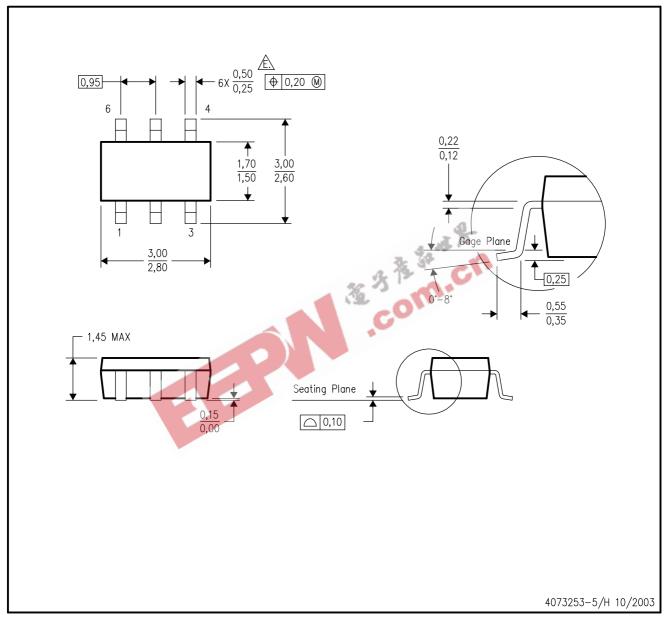


(1) C_L includes probe and jig capacitance.

Figure 21. Total Harmonic Distortion (THD)

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

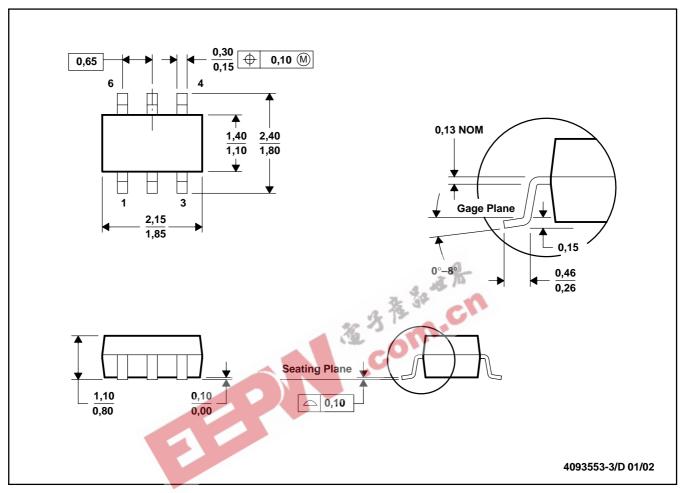
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.

 D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



DCK (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-203

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